

客户图

NOTES:

.FINISH:

- 1.1 HOUSING: BLACK,UL94 V-0
- 1.2 CONTACT: COPPER ALLOY, GOLD (SEE P/N) PLATED IN CONTACT AREA, GOLD FLASH PLATED IN SOLDER AREA, 50u"MIN NICKEL UNDERPLATED OVERALL.

2. ELECTRICAL:

- 2.1 CURRENT RATING: 0.5A AMP.PER CONTACTS,
- 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 200VAC/Minute
- 2.3 CONTACT RESISTANCE: 55mΩ MAX.
- 2.4 INSULATION RESISTANCE: 1000 mΩ Min
- 2.5 Operation Temperature:-40°C to105°C

3.SALT SPRAY TEST:

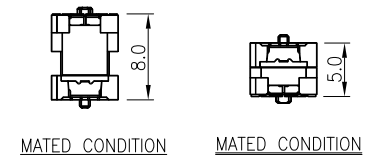
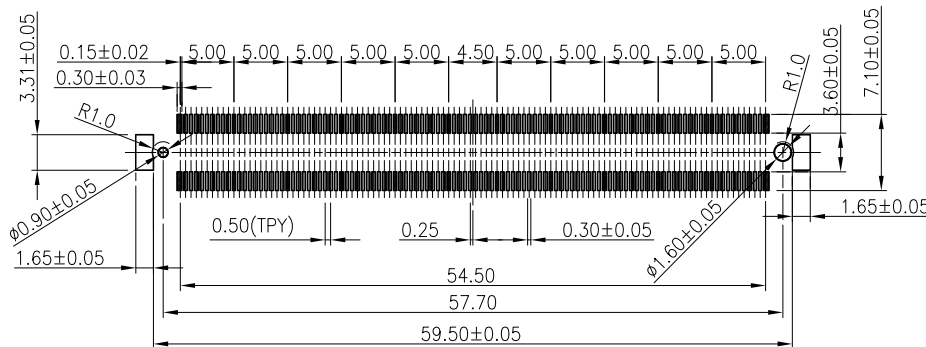
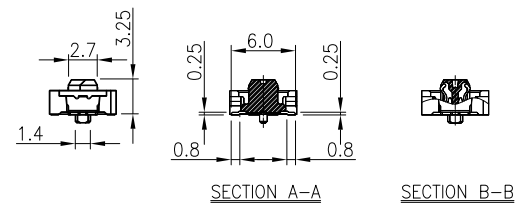
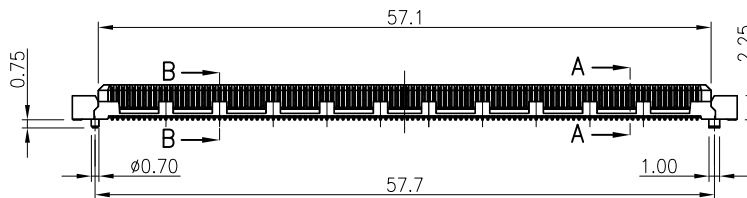
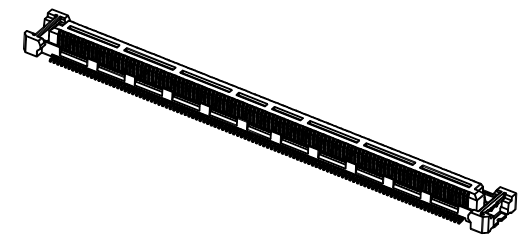
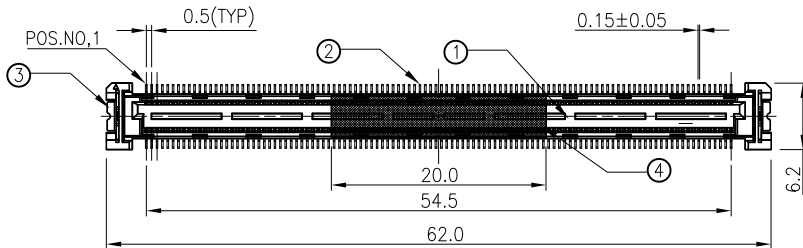
- 3.1 CONCENTRATION IS 5%, THE TEMPERATURE IS 35±2°C, TEST TIME 8H MIN,NO OXIDATION OR RUST

4.Max Processing Temp:265°C Seconds 40S

5.ORDER INFORMATION:

66A5-M 220 SX 032 X 01

Pin数码	端子电镀:	高度:	封装:
SEE TABLE	SN=Gold TIN	032=3.25mm	P=TUBE+CAP
220=2*110PIN	S1=1u"Gold/Tin		R=TAPE REEL
	S2=3u"Gold/Tin		
	S3=5u"Gold/Tin		
	S4=10u"Gold/Tin		



REFERENCE PCB LAYOUT

④	PI-FILM	POLYSTYRENE	1	
③	METAL EAR	STAINLESS STEEL	2	Sn PLATING ON SOLDER AREA
②	CONTACT	COPPER ALLOY	220	Au PLATING ON CONTACT AREA Au PLATING ON SOLDER AREA
①	HOUSING	THERMOPLASTIC	1	COLOR:BLACK ,UL94V-0
ITEM	DESCRIPTION	MATERIAL	QT.Y	REMARK

					OPERATION	DRAW	Mr.Zeng	2024.04.20	WKON 广东稳康精密电子有限公司 CONNECTOR&CABLE Guangdong WKON Precision Electronics Co., Ltd				
					X.X ±0.40	DESIGN	Jensen	2024.04.20					
					X.XX ±0.25	CHECK	Jack	2024.04.20					
					X.XXX ±0.15	APPROVE	Andy	2024.04.20					
AO		NEW			Angle ±3°	UNIT	mm	SCALE	1:1	SIZE	A4	PART NO.	66A5-M 220 SX 032 X 01
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM.	TOL				SHEET	1/1	TITLE:	COME 220PIN 公头
										PROJ.	☞☜	DRAW NO.	WK-0001

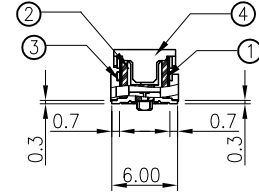
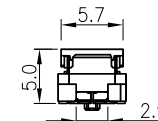
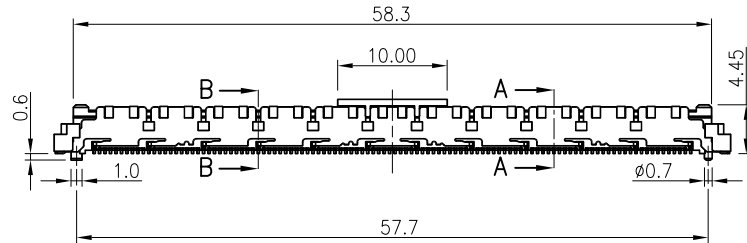
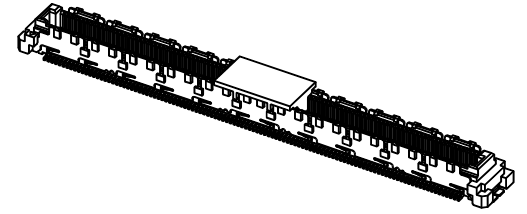
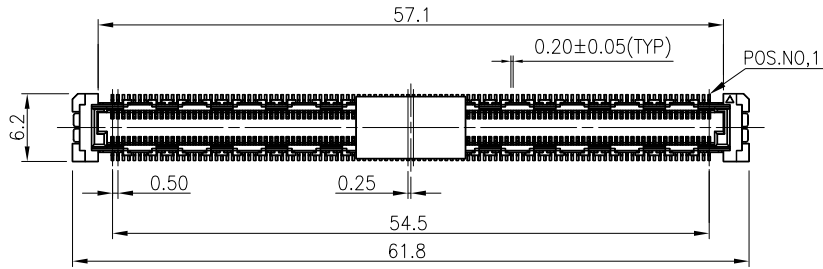
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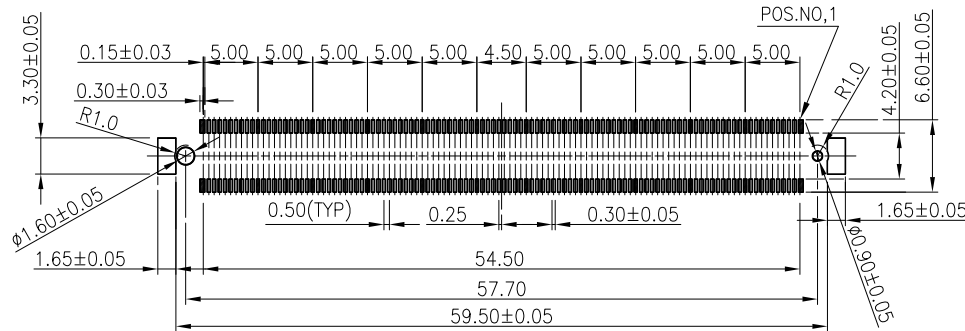
66A5-M 220 SX 050 X 01

Pin数码	端子电镀:	高度:	铆接法:
SEE TABLE	SN=Gold TIN	050=5.00mm	P=TUBE+CAP
220=2*110PIN	S1=1u"Gold/Tin		R=TAPE REEL
	S2=3u"Gold/Tin		
	S3=5u"G0Id/Tin		
	S4=10u"G0Id/Tin		

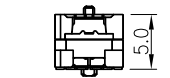


SECTION A-A

SECTION B-B



REFERENCE PCB LAYOUT



MATED CONDITION

④	PICK-UP CAP	THEROPLSTIC	1	
③	METAL SHELL	COPPER ALLOY	2	Pd FLATING ON SOLDER AREA
②	CONTACT	COPPER ALLOY	220	Au PLATING ON CONTACT AREA Au PLATING ON SOLDER AREA
①	HOUSING	THERMOPLASTIC	1	COLOR:BLACK ,UL94V-0
ITEM	DESCRIPTION	MATERIAL	QT.Y	REMARK

				OPERATION		DRAW		Mr.Zeng		2024.04.20		WKON 广东稳康精密电子有限公司 CONNECTOR&CABLE Guangdong WKON Precision Electronics Co., Ltd SIZE A4 PART NO. 66A5-M 220 SX 050 X 01 SHEET 1/1 TITLE: COME-220PIN 母头 合高5mm PROJ. DRAW NO. WK-0002			
				X.X	±0.40	DESIGN		Jensen		2024.04.20					
				X.XX	±0.25	CHECK		Jack		2024.04.20					
				X.XXX	±0.15	APPROVE		Andy		2024.04.20					
AO	NEW					UNIT		mm		SCALE		1:1			
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	APPROVE	DIM.	TOL								

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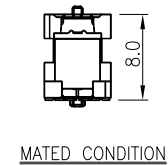
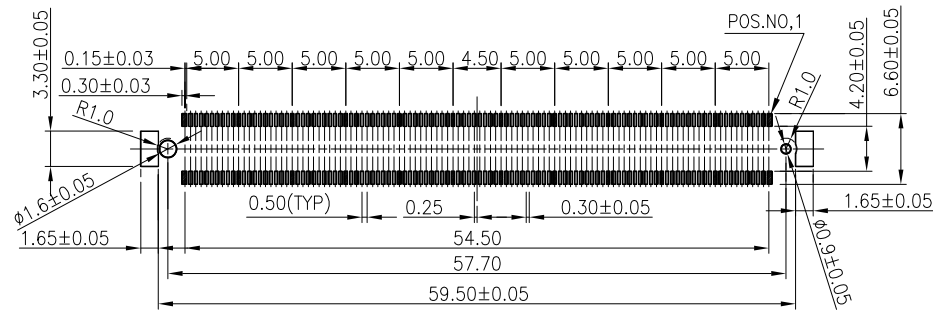
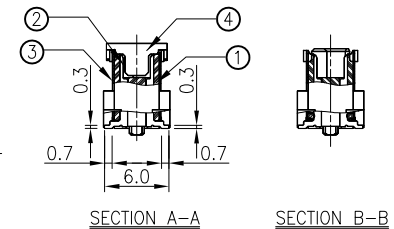
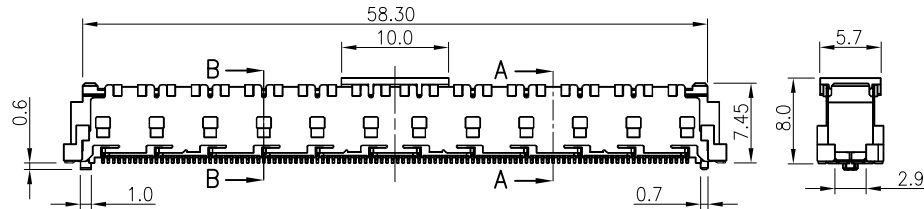
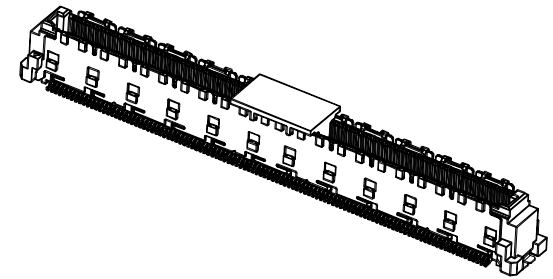
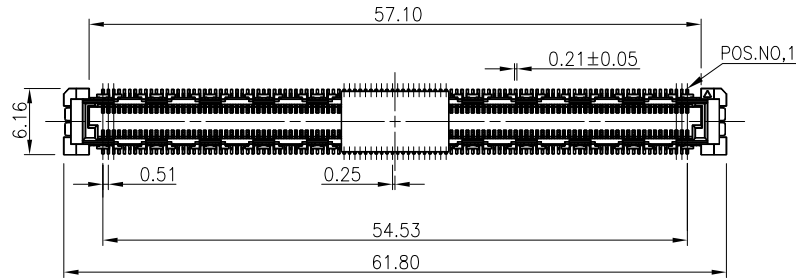
- 3.1 CONCENTRATION IS 5%, THE TEMPERATURE IS 35±2°C, TEST TIME 8H MIN,NO OXIDATION OR RUST

4.Max Processing Temp:265°C Seconds 40S

5.ORDER INFORMATION:

66A5-M 220 SX 080 X 01

Pin数码 SEE TABLE 220=2*110PIN	端子电镀: SN=Gold TIN S1=1u"Gold/Tin S2=3u"Gold/Tin S3=5u"Gold/Tin S4=10u"Gold/Tin	高度: 080=8.00mm	封装: P=TUBE+CAP R=TAPE REEL
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④	PICK-UP CAP	THEROPLSTIC	1	
③	METAL SHELL	COPPER ALLOY	2	Pd FLATING ON SOLDER AREA
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Angle	±3°	UNIT	mm	SCALE 1:1
DIM.	TOL			

WKON 广东稳康精密电子有限公司
CONNECTOR&CABLE Guangdong WKON Precision Electronics Co., Ltd

AO	NEW			
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE

SIZE	A4	PART NO.	66A5-M 220 SX 080 X 01
SHEET	1/1	TITLE:	COME-220PIN 母头 合高8.0mm
PROJ.	☯	DRAW NO.	WK-0003